

Docket No.: JCLA12240-R

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re PATENT APPLICATION of

Applicants: Shei et al.

Serial No.: 10/826,805

Filed: April 16, 2004

For: FLIP-CHIP LIGHT EMITTING DIODE PACKAGE STRUCTURE

PACKAGE STRUCTURE

Shei et al.

Comparison of the properties of the pro

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on August 22, 2005

Signed:

Jiawei Huang

AMENDMENT AND RESPONSE TO OFFICE ACTION

MAIL STOP Amendment

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir,

The Office Action dated June, 21, 2005, has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.